XR79110

22V, 10A Synchronous Step Down COT Power Module

General Description

The XR79110 is a 10A synchronous step-down Power Module for point-of-load supplies. A wide 4.5V to 22V input voltage range allows for single supply operation from industry standard 5V, 12V, and 19.6V rails.

With a proprietary emulated current mode Constant On-Time (COT) control scheme, the XR79110 provides extremely fast line and load transient response using ceramic output capacitors. It requires no loop compensation hence simplifying circuit implementation and reducing overall component count. The control loop also provides 0.35% load and 0.1% line regulation and maintains constant operating frequency. A selectable power saving mode allows the user to operate in discontinuous mode (DCM) at light current loads thereby significantly increasing the converter efficiency. With a 96% peak efficiency and 90% for loads as low as 100mA, the XR79110 is suitable for applications where low power losses are important.

A host of protection features, including over-current, over-temperature, short-circuit and UVLO, help achieve safe operation under abnormal operating conditions.

The XR79110 is available in a RoHS compliant, green/halogen free space-saving 72-pin 10x10x4mm QFN package with a 260°C lead solder temperature. With integrated controller, drivers, bootstrap diode and capacitor, MOSFETs, inductor, CIN and COUT, this solution allows the smallest possible 10A POL design.

FEATURES

- Controller, drivers, bootstrap diode and capacitor, MOSFETs, Inductor, CIN and COUT integrated in one package
- 10A Step Down Module
  - □ Wide 4.5V to 22V Input Voltage Range
  - □ >0.6V Adjustable Output Voltage
- Proprietary Constant On-Time Control
  - □ No Loop Compensation Required
  - □ Stable Ceramic Output Capacitor Operation
  - □ Programmable 200ns to 2µs On-Time
  - □ Constant 400kHz to 800kHz Frequency
- Selectable CCM or CCM/DCM
  - □ CCM/DCM for high efficiency at light-load
  - □ CCM for constant frequency at light-load
- Programmable Hiccup Current Limit with Thermal Compensation
- Precision Enable and Power Good flag
- Programmable Soft-start
- 72-pin 10x10x4mm QFN package 260°C solder temperature
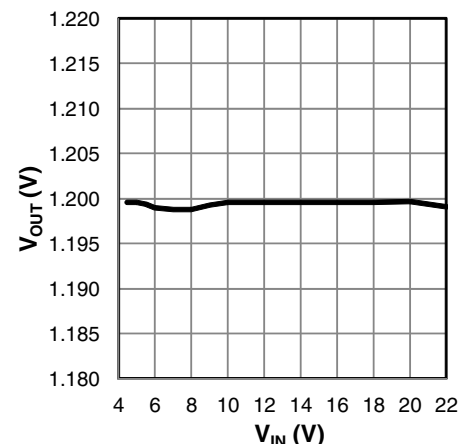
APPLICATIONS

- Networking and Communications
- Fast Transient Point-of-Loads
- Industrial and Medical Equipment
- Embedded High Power FPGA

Ordering Information – back page

Typical Application
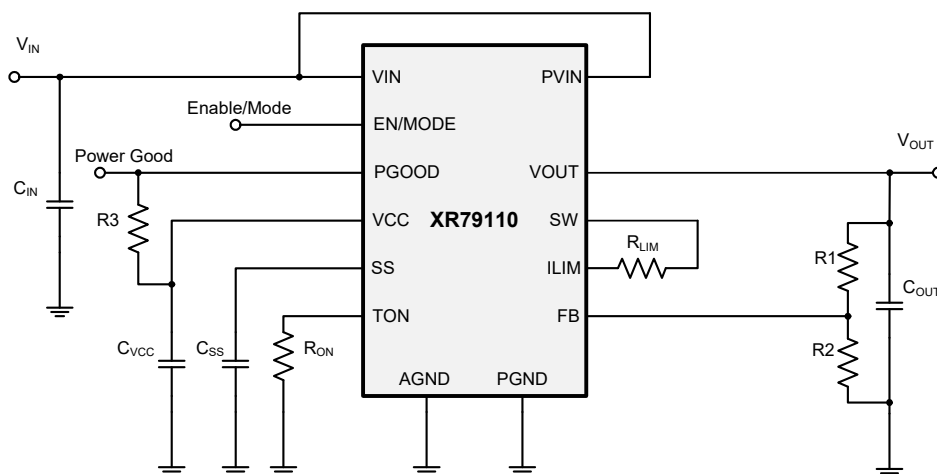
Line Regulation

Absolute Maximum Ratings

Stresses beyond the limits listed below may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

PV$_{IN}$, V$_{IN}$..-0.3V to 25V

V$_{CC}$..-0.3V to 6.0V

BST..-0.3V to 31V[1]

BST-SW..-0.3V to 6V

SW, ILIM...-1V to 25V[1, 2]

ALL other pins..-0.3V to VCC+0.3V

Storage Temperature..-65°C to +150°C

Junction Temperature...150°C

Power Dissipation..Internally Limited

Lead Temperature (Soldering, 10 sec)......................260°C MSL3

ESD Rating (HBM - Human Body Model)..............................2kV

ESD Rating (CDM - Charged Device Model)..........................2kV

Operating Conditions

PV$_{IN}$..3V to 22V

V$_{IN}$...4.5V to 22V

V$_{CC}$...4.5V to 5.5V

SW, ILIM..-1V to 22V[1]

PGOOD, V$_{CC}$, T$_{ON}$, SS, EN, FB.............................-0.3V to 5.5V

Switching Frequency....................................400kHz to 800kHz[3]

Junction Temperature Range..............................-40°C to +125°C

JEDEC51 Package Thermal Resistance, θ_{JA}................18.1°C/W

Package Power Dissipation at 25°C.....................................5.5W

Note 1: No external voltage applied.

Note 2: SW pin's minimum DC range is -1V, transient is -5V for less than 50ns, -7V for less than 20ns, -9V for less than 10ns.

Note 3: Upper limit is a guideline based upon thermal performance.

Electrical Characteristics

Unless otherwise noted: T$_J$= 25°C, V$_{IN}$=12V, BST=V$_{CC}$, SW=AGND=PGND=0V, C$_{VCC}$=4.7uF. Limits applying over the full operating temperature range are denoted by a "•"
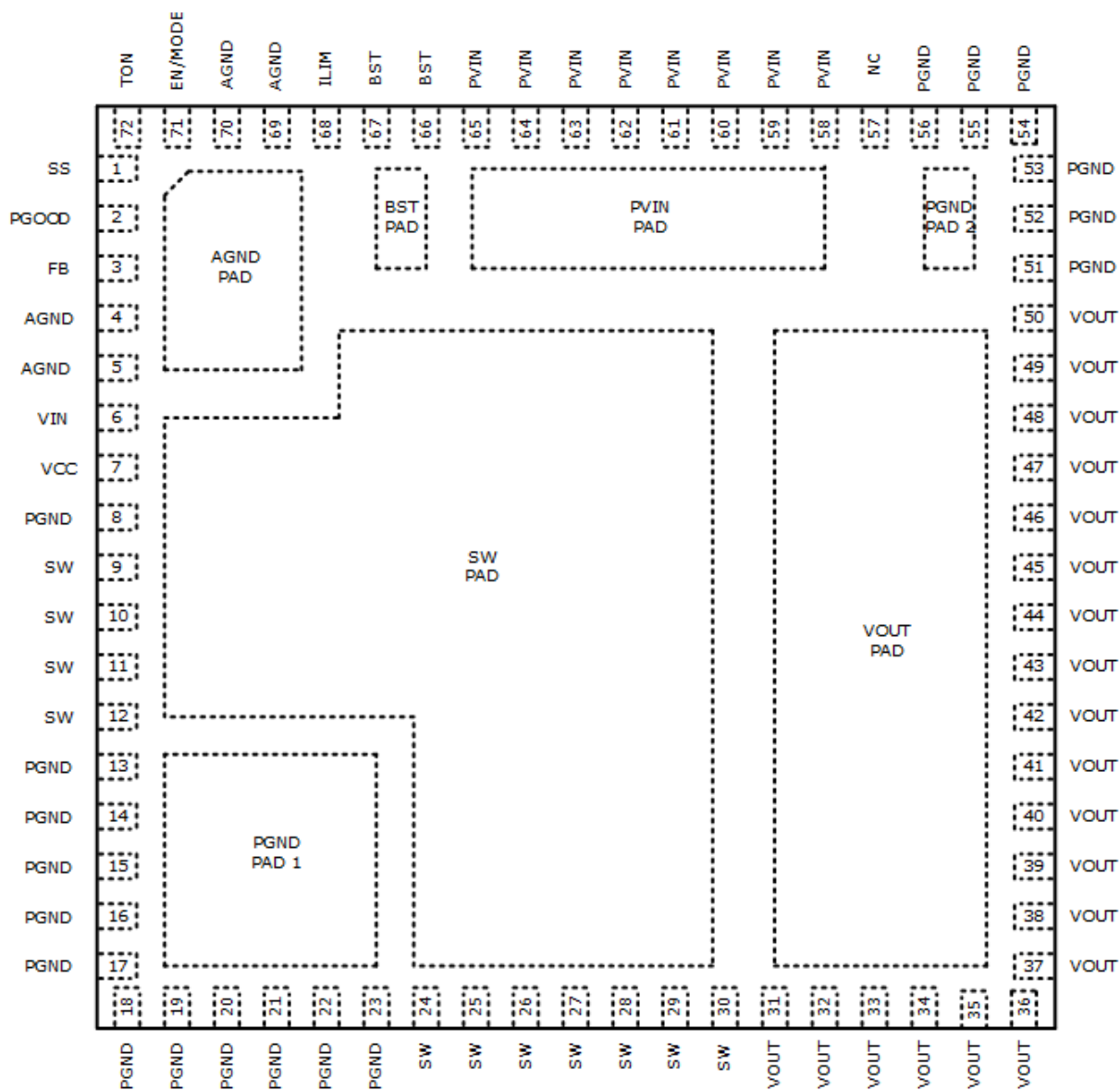
Symbol	Parameter	Conditions		Min	Typ	Max	Units
Power Supply Characteristics							
V$_{IN}$	Input Voltage Range	VCC regulating or in dropout	•	4.5		22	V
		VCC tied to VIN	•	4.5		5.5	
I$_{VIN}$	VIN Input Supply Current	Not switching, V$_{IN}$ = 12V, V$_{FB}$ = 0.7V	•		0.7	2	mA
I$_{VCC}$	VCC Quiescent Current	Not switching, V$_{CC}$=V$_{IN}$ = 5V, V$_{FB}$ = 0.7V	•		0.7	2	mA
I$_{VIN}$	VIN Input Supply Current	f=500kHz, R$_{ON}$=61.9k, VFB=0.58V			11		mA
I$_{OFF}$	Shutdown Current	Enable = 0V, V$_{IN}$ = 12V			1		µA
Enable and Under-Voltage Lock-Out UVLO							
V$_{IH\_EN}$	EN Pin Rising Threshold		•	1.8	1.9	2.0	V
V$_{EN\_HYS}$	EN Pin Hysteresis				50		mV
V$_{IH\_EN}$	EN Pin Rising Threshold for DCM/CCM operation		•	2.8	3.0	3.1	V
V$_{EN\_HYS}$	EN Pin Hysteresis				100		mV

Symbol	Parameter	Conditions		Min	Typ	Max	Units
	VCC UVLO Start Threshold, Rising Edge		•	4.00	4.25	4.40	V
	VCC UVLO Hysteresis		•	150	200		mV
Reference Voltage							
V_{REF}	Reference Voltage	V_{IN} = 5V to 22V, VCC regulating		0.597	0.600	0.603	V
		V_{IN} = 4.5V to 5.5V, VCC tied to VIN		0.596	0.600	0.604	V
		V_{IN} = 5V to 22V, VCC regulating	•	0.594	0.600	0.606	V
		V_{IN} = 4.5V to 5.5V, VCC tied to VIN					
	DC Line Regulation	CCM, closed loop, V_{IN}=4.5V-22V, applies to any C_{OUT}			±0.10		%
	DC Load Regulation	CCM, closed loop, I_{OUT}=0A-15A, applies to any C_{OUT}			±0.35		%
Programmable Constant On-Time							
$T_{ON(MIN)}$	Minimum Programmable On-Time	R_{ON} = 6.98k, V_{IN} = 22V			120		ns
T_{ON2}	On-Time 2	R_{ON} = 6.98k, V_{IN} = 12V	•	148	184	220	ns
	f Corresponding to On-Time 2	V_{OUT} = 1.0V		468	560	695	kHz
T_{ON3}	On-Time 3	R_{ON} = 16.2k, V_{IN} = 12V	•	319	390	461	ns
	Minimum Off-Time		•		250	350	ns
Diode Emulation Mode							
	Zero Crossing Threshold	DC value measured during test			-2		mV
Soft-start							
	SS Charge Current		•	-14	-10	-6	µA
	SS Discharge Current	Fault present	•	1			mA
VCC Linear Regulator							
	VCC Output Voltage	V_{IN} = 6V to 22V, I_{LOAD} = 0 to 30mA	•	4.8	5.0	5.2	V
		V_{IN} = 4.5V, R_{ON} = 16.2k, f=670kHz	•	4.3	4.37		V
Power Good Output							
	Power Good Threshold			-10	-7.5	-5	%
	Power Good Hysteresis				2	4	%
	Power Good Sink Current			1			mA
Protection: OCP, OTP, Short-Circuit							
	Hiccup Timeout				110		ms
	ILIM Pin Source Current			45	50	55	µA
	ILIM Current Temperature Coefficient				0.4		%/°C
	OCP Comparator Offset		•	-8	0	+8	mV

Symbol	Parameter	Conditions		Min	Typ	Max	Units
	Current Limit Blanking	GL rising>1V			100		ns
	Thermal Shutdown Threshold[1]	Rising temperature			150		°C
	Thermal Hysteresis[1]				15		°C
	VSCTH Feedback Pin Short-Circuit Threshold	Percent of V_{REF}, short circuit is active after PGOOD is asserted	●	50	60	70	%
Output Power Stage							
R_{DSON}	High-Side MOSFET R_{DSON}	I_{DS} = 2A, V_{GS}=4.5V			8.2	10	mΩ
	Low-Side MOSFET R_{DSON}				7.8	10	mΩ
I_{OUT}	Maximum Output Current		●	10			A
L	Output Inductance			0.64	0.80	0.96	uH
C_{IN}	Input Capacitance				1		uF
C_{OUT}	Output Capacitance				2.2		uF
C_{BST}	Bootstrap Capacitance				0.1		uF

Note 1: Guaranteed by design

Pin Configuration, Top View

Top pins (72–54): TON, EN/MODE, AGND, AGND, ILIM, BST, BST, PVIN, PVIN, PVIN, PVIN, PVIN, PVIN, PVIN, PVIN, NC, PGND, PGND, PGND

Left pins (1–17): SS, PGOOD, FB, AGND, AGND, VIN, VCC, PGND, SW, SW, SW, SW, PGND, PGND, PGND, PGND, PGND

Bottom pins (18–36): PGND, PGND, PGND, PGND, PGND, PGND, SW, SW, SW, SW, SW, SW, SW, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT

Right pins (53–37): PGND, PGND, PGND, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT, VOUT

Center pads: AGND PAD, BST PAD, PVIN PAD, PGND PAD 2, SW PAD, PGND PAD 1, VOUT PAD

Pin Assignments

Pin No.	Pin Name	Type	Description
1	SS	A	Soft-start pin. Connect an external capacitor between SS and AGND to program the soft-start rate based on the 10uA internal source current.
2	PGOOD	OD, O	Power-good output. This open-drain output is pulled low when V_{OUT} is outside the regulation.
3	FB	A	Feedback input to feedback comparator. Connect with a set of resistors to VOUT and AGND in order to program VOUT.
4, 5, 69, 70, AGND Pad	AGND	A	Analog ground. Control circuitry of the IC is referenced to this pin.
6	VIN	PWR	IC supply input. Provides power to internal LDO.
7	VCC	PWR	The output of LDO. Bypass with a 4.7uF capacitor to AGND. For operation from a 5V_{IN} rail, VCC should be tied to VIN.
8	PGND	PWR	Controller low-side driver ground. Connect with a short trace to closest PGND pins or PGND pad.
13-23, 51-56, PGND pads	PGND	PWR	Ground of the power stage. Should be connected to the system's power ground plane.
9-12, 24-30, SW Pad	SW	PWR	Switching node. It is internally connected. Use thermal vias and/or sufficient PCB land area in order to heatsink the low-side FET and the inductor.
31-50, VOUT Pad	VOUT	PWR	Output of the power stage. Place the output filter capacitors as close as possible to these pins.
58-65, PVIN Pad	PVIN	PWR	Power stage input voltage. Place the input filter capacitors as close as possible to these pins.
66, 67, BST Pad	BST	A	Controller high-side driver supply pin. It is internally connected to SW via a 0.1uF bootstrap capacitor. Leave these pins floating.
68	ILIM	A	Over-current protection programming. Connect with a short trace to SW pins.
71	EN/MODE	I	Precision enable pin. Pulling this pin above 1.9V will turn the IC on and it will operate in Forced CCM. If the voltage is raised above 3.0V, then the IC will operate in DCM or CCM depending on load.
72	TON	A	Constant on-time programming pin. Connect with a resistor to AGND.

Type: A = Analog, I = Input, O = Output, I/O = Input/Output, PWR = Power, OD = Open-Drain

Functional Block Diagram
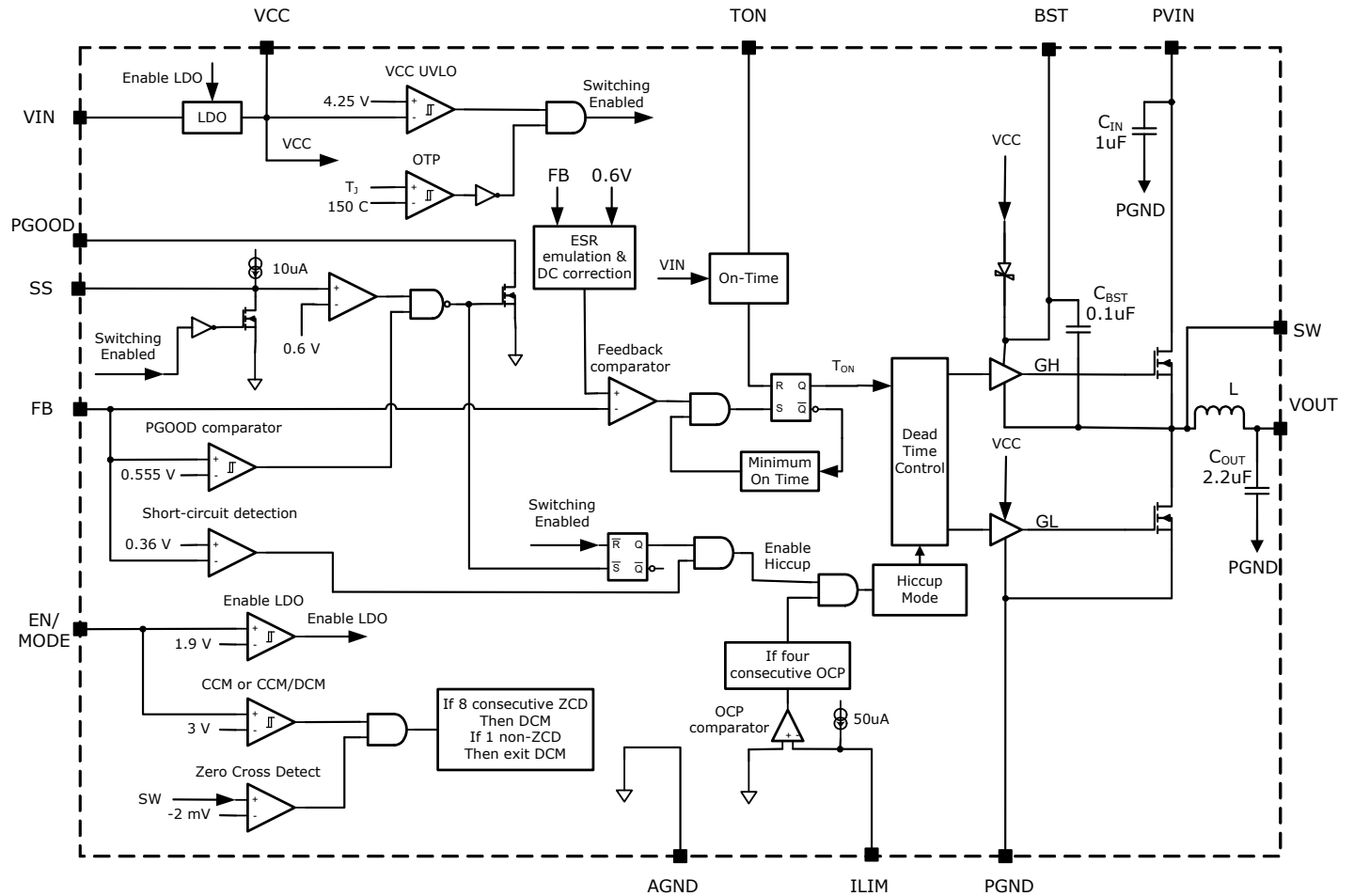
Typical Performance Characteristics

Unless otherwise noted: V_{IN} = 12V, V_{OUT}=1.2V, I_{OUT}=10A, f=500kHz, T_A = 25°C. Schematic from the application information section.
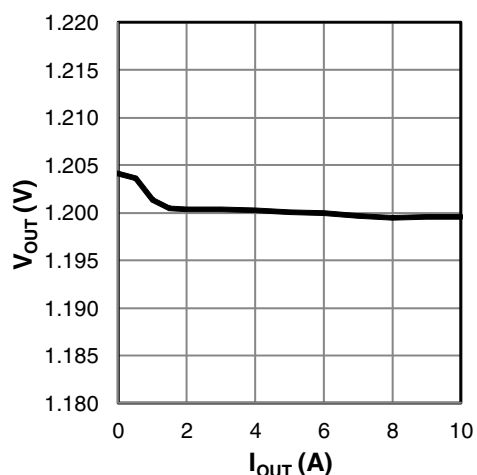

Figure 1: Load Regulation
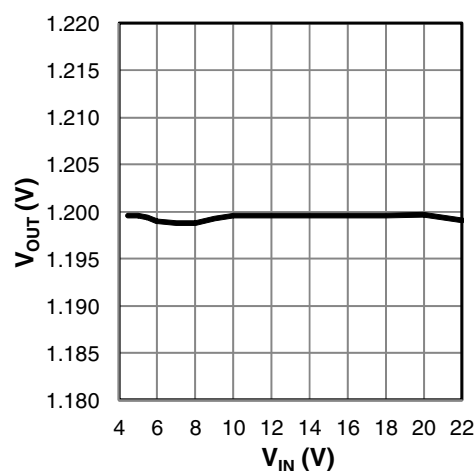
Figure 2: Line regulation
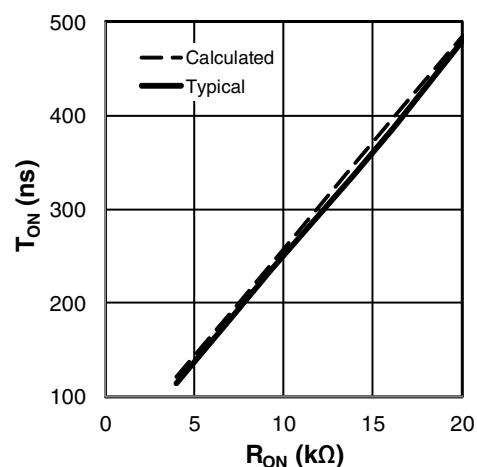
Figure 3: T_{ON} versus R_{ON}
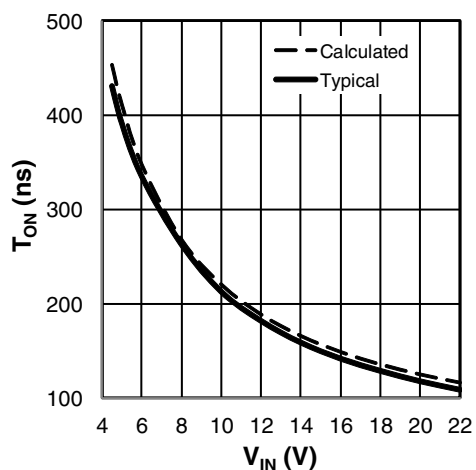
Figure 4: T_{ON} versus V_{IN}, R_{ON}=6.98k
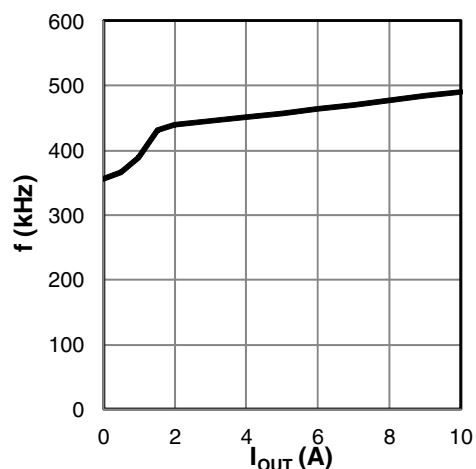
Figure 5: frequency versus I_{OUT}
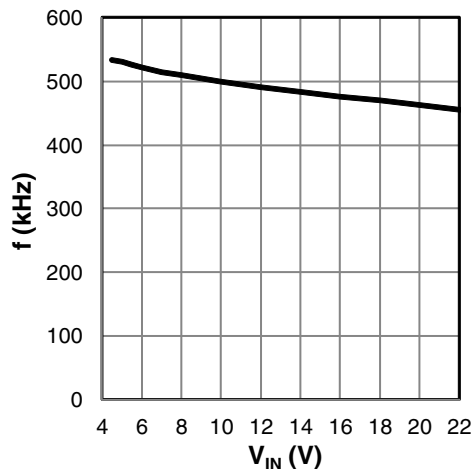
Figure 6: frequency versus V_{IN}

Typical Performance Characteristics

Unless otherwise noted: V_{IN} = 12V, V_{OUT}=1.2V, I_{OUT}=10A, f=500kHz, T_A = 25°C. Schematic from the application information section.
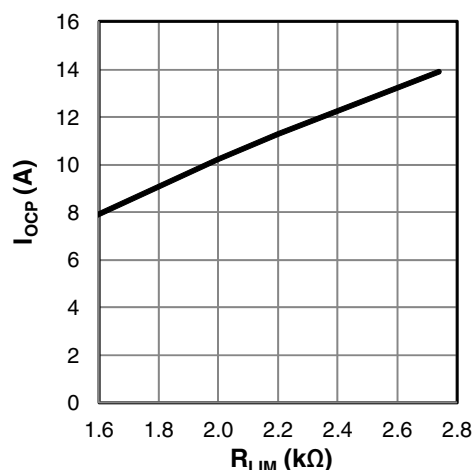
Figure 7: I_{OCP} versus R_{LIM}
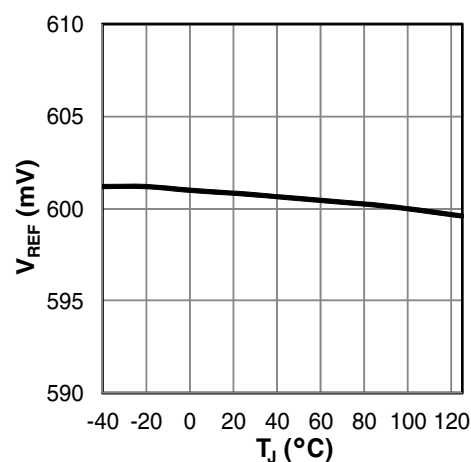
Figure 8: V_{REF} versus temperature
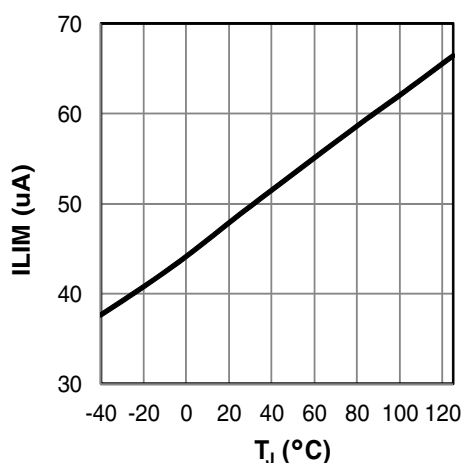
Figure 9: I_{LIM} versus temperature
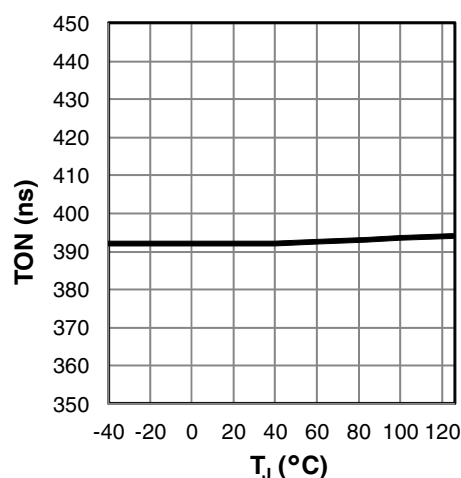
Figure 10: T_{ON} versus temperature, R_{ON}=16.2kΩ
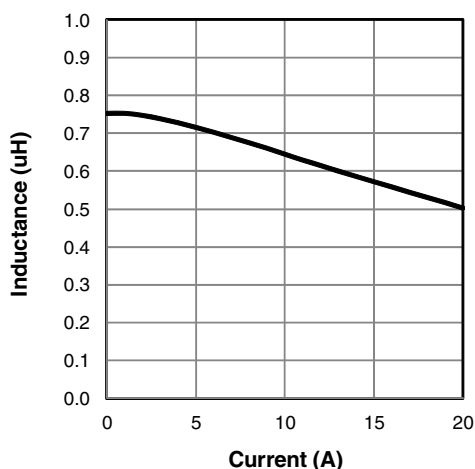
Figure 11: Inductance versus Current
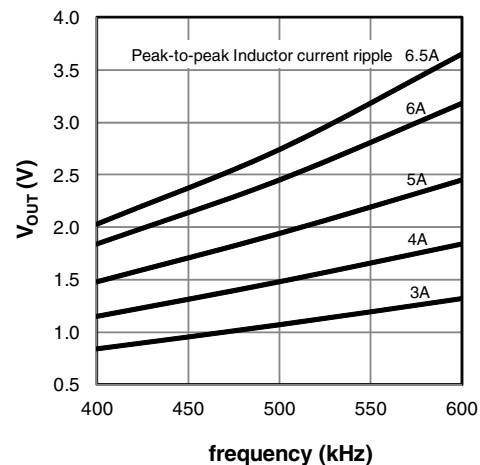
Figure 12: V_{OUT} versus f, V_{IN}=12V

Typical Performance Characteristics

Unless otherwise noted: V_{IN} = 12V, V_{OUT}=1.2V, I_{OUT}=10A, f=500kHz, T_A = 25°C. Schematic from the application information section.
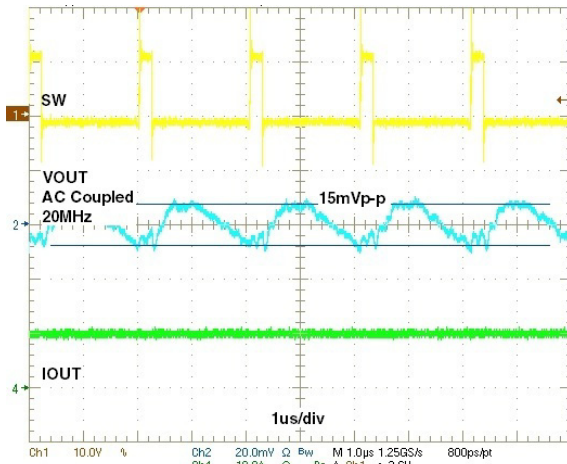
Figure 13: Steady state, CCM, I_{OUT}=10A
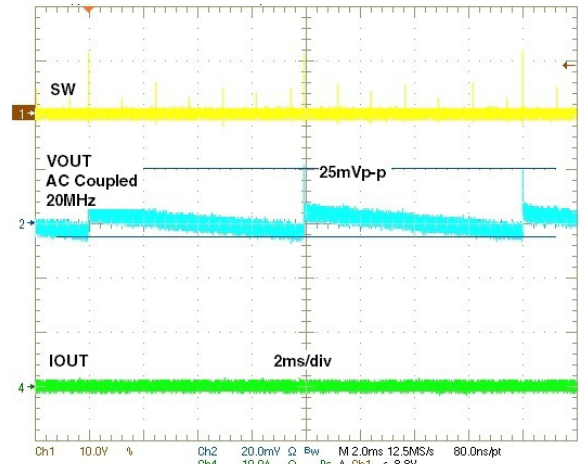
Figure 14: Steady state, DCM, I_{OUT}=0A
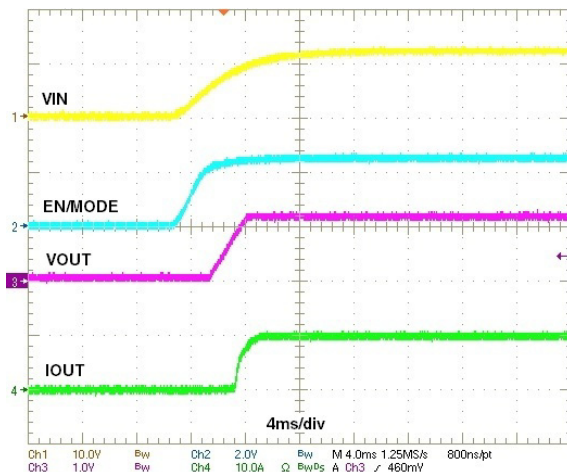
Figure 15: Power up, Forced CCM
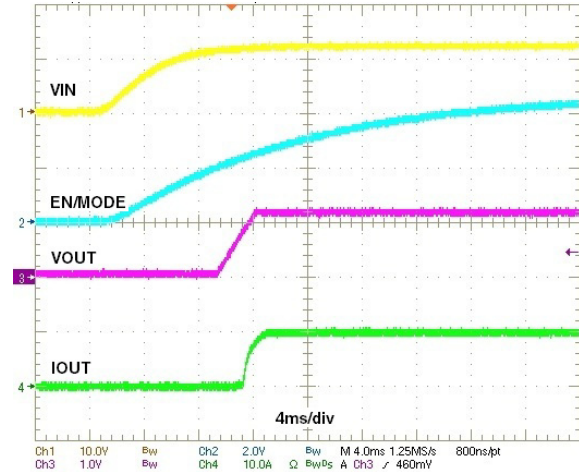
Figure 16: Power up, DCM/CCM
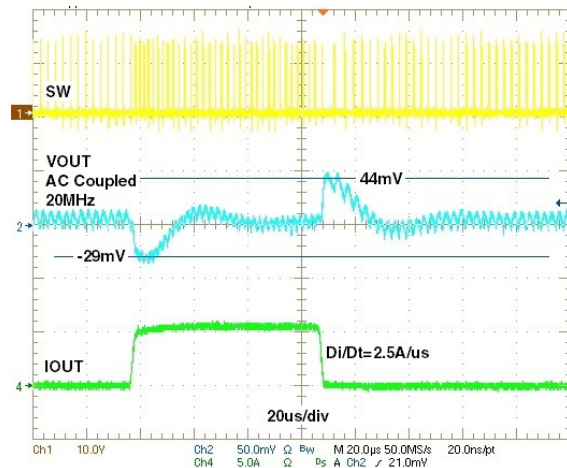
Figure 17: Load step, Forced CCM, 0A-5A-0A
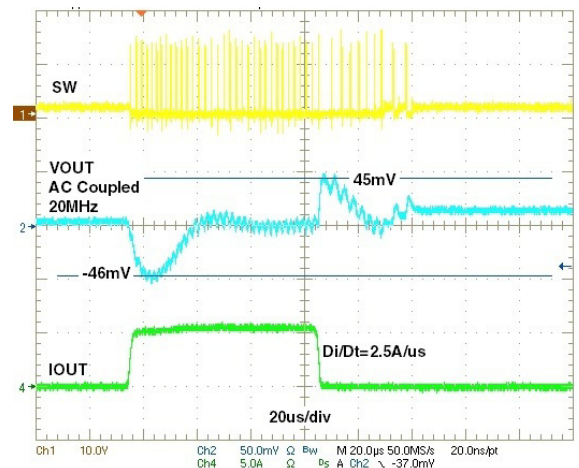
Figure 18: Load step, DCM/CCM, 0A-5A-0A

Efficiency and Package Thermal Derating

Unless otherwise noted: $T_{AMBIENT}$ = 25°C, No Air flow, f=500kHz, Schematic from the application information section.
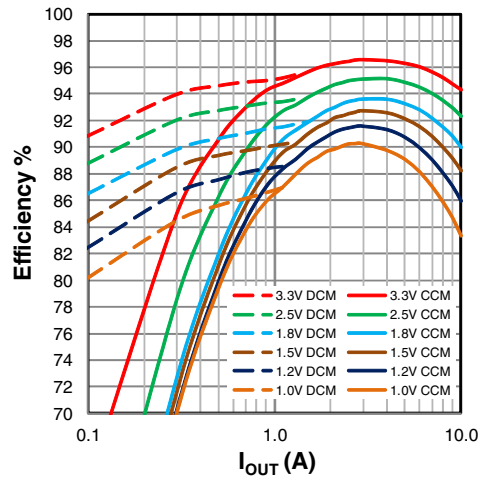
Figure 19: Efficiency, V_{IN}=5V
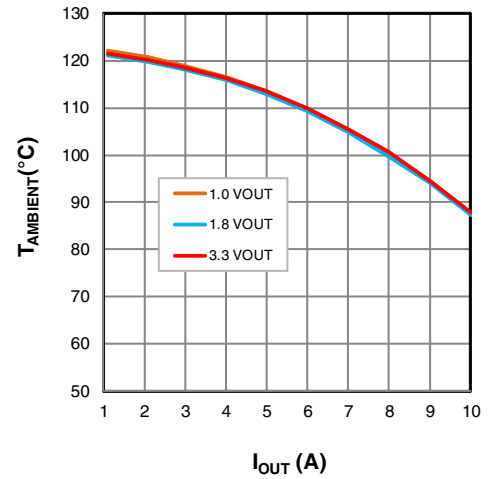
Figure 20: Maximum $T_{AMBIENT}$ vs I_{OUT}, V_{IN}=5V
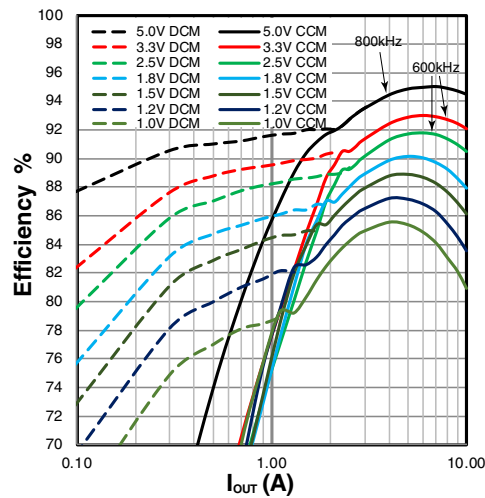
Figure 21: Efficiency, V_{IN}=12V
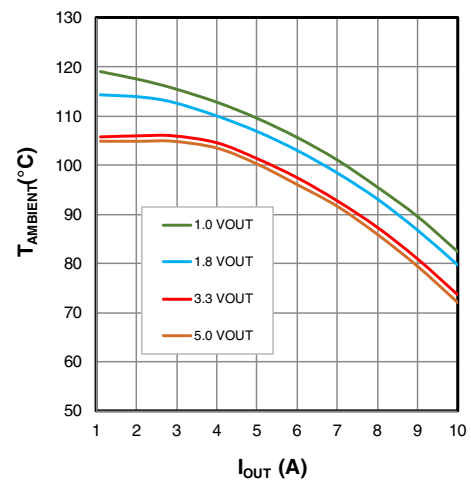
Figure 22: Maximum $T_{AMBIENT}$ vs I_{OUT}, V_{IN}=12V
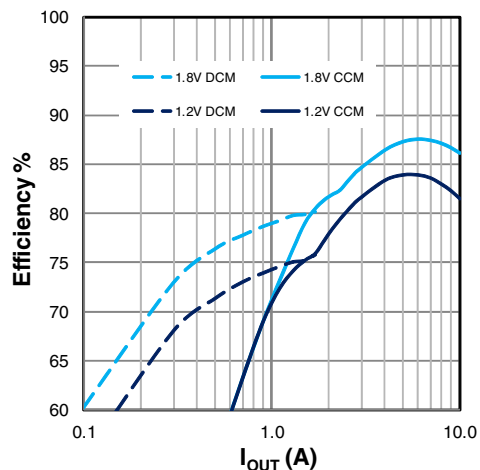
Figure 23: Efficiency, V_{IN}=19.6V
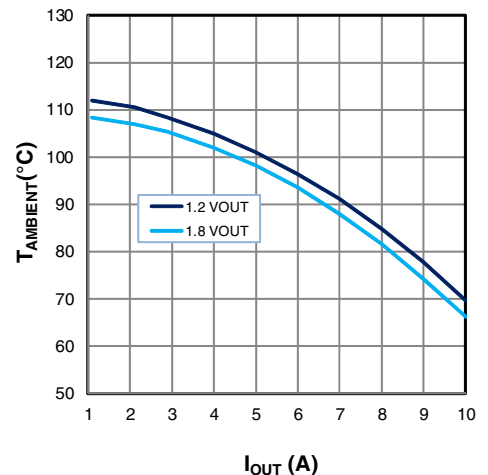
Figure 24: Maximum $T_{AMBIENT}$ vs I_{OUT}, V_{IN}=19.6V

Functional Description

XR79110 is a synchronous step-down proprietary emulated current-mode Constant On-Time (COT) Module. The on-time, which is programmed via R_{ON}, is inversely proportional to V_{IN} and maintains a nearly constant frequency. The emulated current-mode control is stable with ceramic output capacitors.

Each switching cycle begins with GH signal turning on the high-side (switching) FET for a preprogrammed time. At the end of the on-time, the high-side FET is turned off and the low-side (synchronous) FET is turned on for a preset minimum time (250ns nominal). This parameter is termed Minimum Off-Time. After the minimum off-time, the voltage at the feedback pin FB is compared to an internal voltage ramp at the feedback comparator. When V_{FB} drops below the ramp voltage, the high-side FET is turned on and the cycle repeats. This voltage ramp constitutes an emulated current ramp and makes possible the use of ceramic capacitors, in addition to other capacitor types, for output filtering.

Enable/Mode Input (EN/MODE)

EN/MODE pin accepts a tri-level signal that is used to control turn on/off. It also selects between two modes of operation: 'Forced CCM' and 'DCM/CCM'. If EN is pulled below 1.8V, the Module shuts down. A voltage between 2.0V and 2.8V selects the Forced CCM mode which will run the Module in continuous conduction at all times. A voltage higher than 3.1V selects the DCM/CCM mode which will run the Module in discontinuous conduction at light loads.

Selecting the Forced CCM Mode

In order to set the Module to operate in Forced CCM, a voltage between 2.0V and 2.8V must be applied to EN/MODE. This can be achieved with an external control signal that meets the above voltage requirement. Where an external control is not available, the EN/MODE can be derived from V_{IN}. If V_{IN} is well regulated, use a resistor divider and set the voltage to 2.5V. If V_{IN} varies over a wide range, the circuit shown in figure 25 can be used to generate the required voltage. Note that at V_{IN} of 5V and 22V the nominal Zever voltage is 3.8V and 4.7V respectively. Therefore for V_{IN} in the range of 5V to 22V, the circuit shown in figure 25 will generate V_{EN} required for Forced CCM.

Selecting the DCM/CCM Mode

In order to set the Module operation to DCM/CCM, a voltage between 3.1V and 5.5V must be applied to EN/MODE pin. If an external control signal is available, it can be directly connected to EN/MODE. In applications where an external control is not available, EN/MODE input can be derived from V_{IN}. If V_{IN} is well regulated, use a resistor

divider and set the voltage to 4V. If V_{IN} varies over a wide range, the circuit shown in figure 26 can be used to generate the required voltage.
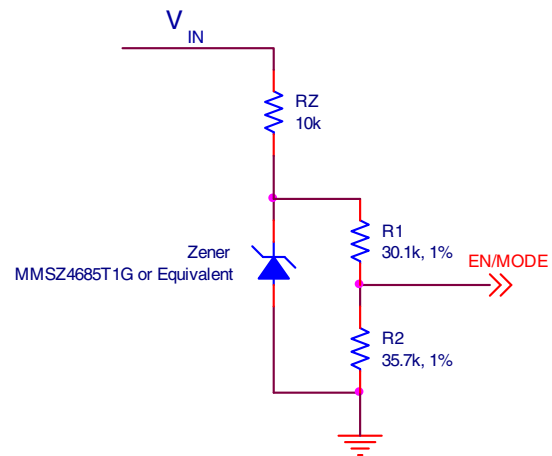
Figure 25: Selecting Forced CCM by deriving EN/MODE from V_{IN}
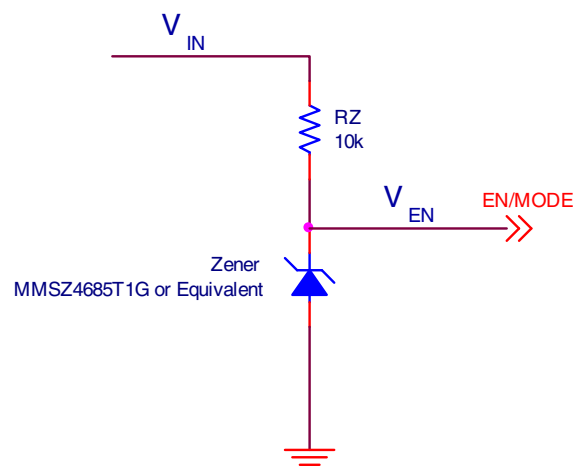

Figure 26: Selecting DCM/CCM by deriving EN/MODE from V_{IN}

Programming the On-Time

The On-Time T_{ON} is programmed via resistor R_{ON} according to following equation:

$$R_{ON} = \frac{V_{IN} \times [T_{ON} - (25 \times 10^{-9})]}{2.7 \times 10^{-10}}$$

where T_{ON} is calculated from:

$$T_{ON} = \frac{V_{OUT}}{V_{IN} \times f \times Eff}$$

where:

f is the desired switching frequency at nominal I_{OUT}

Eff is the Module efficiency corresponding to nominal I_{OUT} shown in figures 19, 21, 23

Substituting for T_{ON} in the first equation we get:

$$R_{ON} = \frac{\left(\frac{V_{OUT}}{f \times Eff}\right) - [(25 \times 10^{-9}) \times V_{IN}]}{2.7 \times 10^{-10}}$$

Over-Current Protection (OCP)

If load current exceeds the programmed over-current, I_{OCP}, for four consecutive switching cycles, then Module enters hiccup mode of operation. In hiccup, the MOSFET gates are turned off for 110ms (hiccup timeout). Following the hiccup timeout, a soft-start is attempted. If OCP persists, hiccup timeout will repeat. The Module will remain in hiccup mode until load current is reduced below the programmed I_{OCP}. In order to program the over-current protection, use the following equation:

$$RLIM = \frac{(I_{OCP} \times RDS) + 8mV}{ILIM}$$

Where:

RLIM is resistor value for programming I_{OCP}

I_{OCP} is the over-current threshold to be programmed

RDS is the MOSFET rated On Resistance (10mΩ)

8mV is the OCP comparator maximum offset

ILIM is the internal current that generates the necessary OCP comparator threshold (use 45µA).

Note that ILIM has a positive temperature coefficient of 0.4%/°C (figure 9). This is meant to roughly match and compensate for positive temperature coefficient of the synchronous FET. Graph of typical I_{OCP} versus RLIM is shown in figure 7.

Short-Circuit Protection (SCP)

If the output voltage drops below 60% of its programmed value, the Module will enter hiccup mode. Hiccup will persist until short-circuit is removed. SCP circuit becomes active after PGOOD asserts high.

Over-Temperature (OTP)

OTP triggers at a nominal die temperature of 150°C. The gate of switching FET and synchronous FET are turned off. When die temperature cools down to 135°C, soft-start is initiated and operation resumes.

Programming the Output Voltage

Use an external voltage divider as shown in the Application Circuit to program the output voltage V_{OUT}.

$$R1 = R2 \times \left(\frac{V_{OUT}}{0.6} - 1\right)$$

where R2 has a nominal value of 2kΩ.

Programming the Soft-start

Place a capacitor CSS between the SS and AGND pins to program the soft-start. In order to program a soft-start time of TSS, calculate the required capacitance CSS from the following equation:

$$CSS = TSS \times \left(\frac{10µA}{0.6V}\right)$$

Feed-Forward Capacitor (C_{FF})

A feed-forward capacitor (C_{FF}) may be necessary depending on the Equivalent Series Resistance (ESR) of C_{OUT}. If

only ceramic output capacitors are used for C_{OUT} then a C_{FF} is necessary. Calculate C_{FF} from:

$$C_{FF} = \frac{1}{2 \times \pi \times 80\,kHz \times R1}$$

where:

R1 is the resistor that C_{FF} is placed in parallel with

80kHz is the location of the Zero formed by R1 and C_{FF}

Note that minimum required C_{OUT} is 90uF when using ceramic capacitors.

When using capacitors with higher ESR, such as PANA-SONIC TPE series, a C_{FF} is not required provided following conditions are met:

1. The frequency of output filter LC double-pole f_{LC} should be less than 15kHz.

2. The frequency of ESR Zero $f_{Zero,ESR}$ should be at least three times larger than f_{LC}.

As an example the application circuit has f_{LC}=8.3kHz and $f_{Zero,ESR}$=48kHz.

Maximum Allowable Voltage Ripple at FB pin

Note that the steady-state voltage ripple at feedback pin FB ($V_{FB,RIPPLE}$) must not exceed 50mV in order for the Module to function correctly. If $V_{FB,RIPPLE}$ is larger than 50mV then C_{OUT} should be increased as necessary in order to keep the $V_{FB,RIPPLE}$ below 50mV.

Feed-Forward Resistor (R_{FF})

Poor PCB layout can cause FET switching noise at the output that may couple to the FB pin via C_{FF}. Excessive noise at FB will cause poor load regulation. To solve this problem place a resistor R_{FF} in series with C_{FF}. R_{FF} value up to 2% of R1 is acceptable.
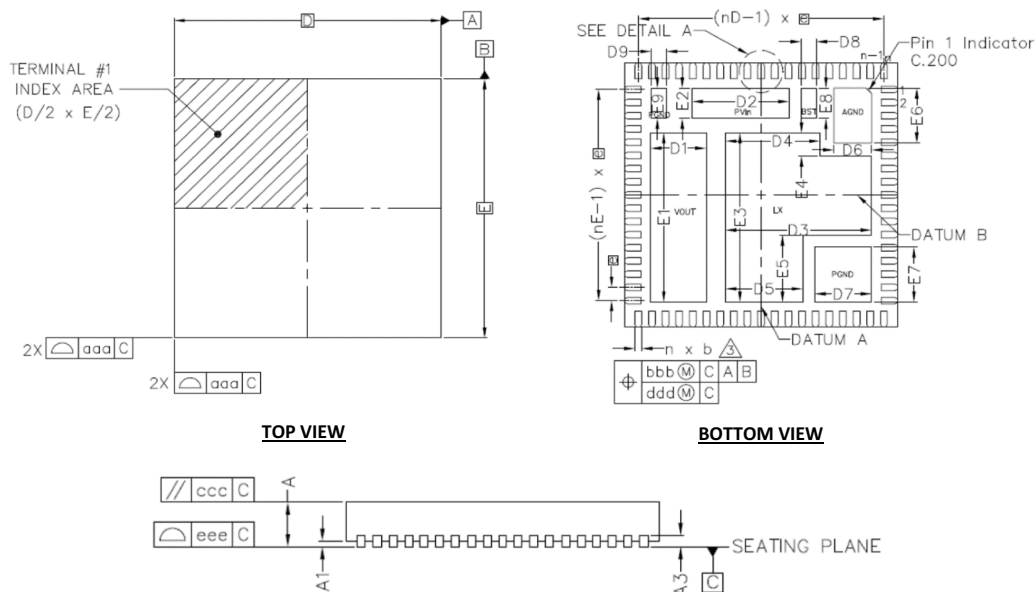
V_{OUT} versus frequency curves

V_{OUT} versus switching frequency (f) curves corresponding to peak-to-peak inductor current ripple (ΔIL) are plotted in figure 12. For a particular V_{IN}, V_{OUT} and f the magnitude of ΔIL can be determined from figure 12. As an example, for V_{IN}=12V, V_{OUT}=1.5V and f=400kHz the ΔIL is 5A. Alternately for a given V_{IN}, V_{OUT} and ΔIL the required switching

frequency can be ascertained. For example for V_{IN}=12V, V_{OUT}=1.5V and ΔIL=4A the required f is 500kHz.

Application Circuit

Mechanical Dimensions

TOP VIEW

BOTTOM VIEW

SIDE VIEW
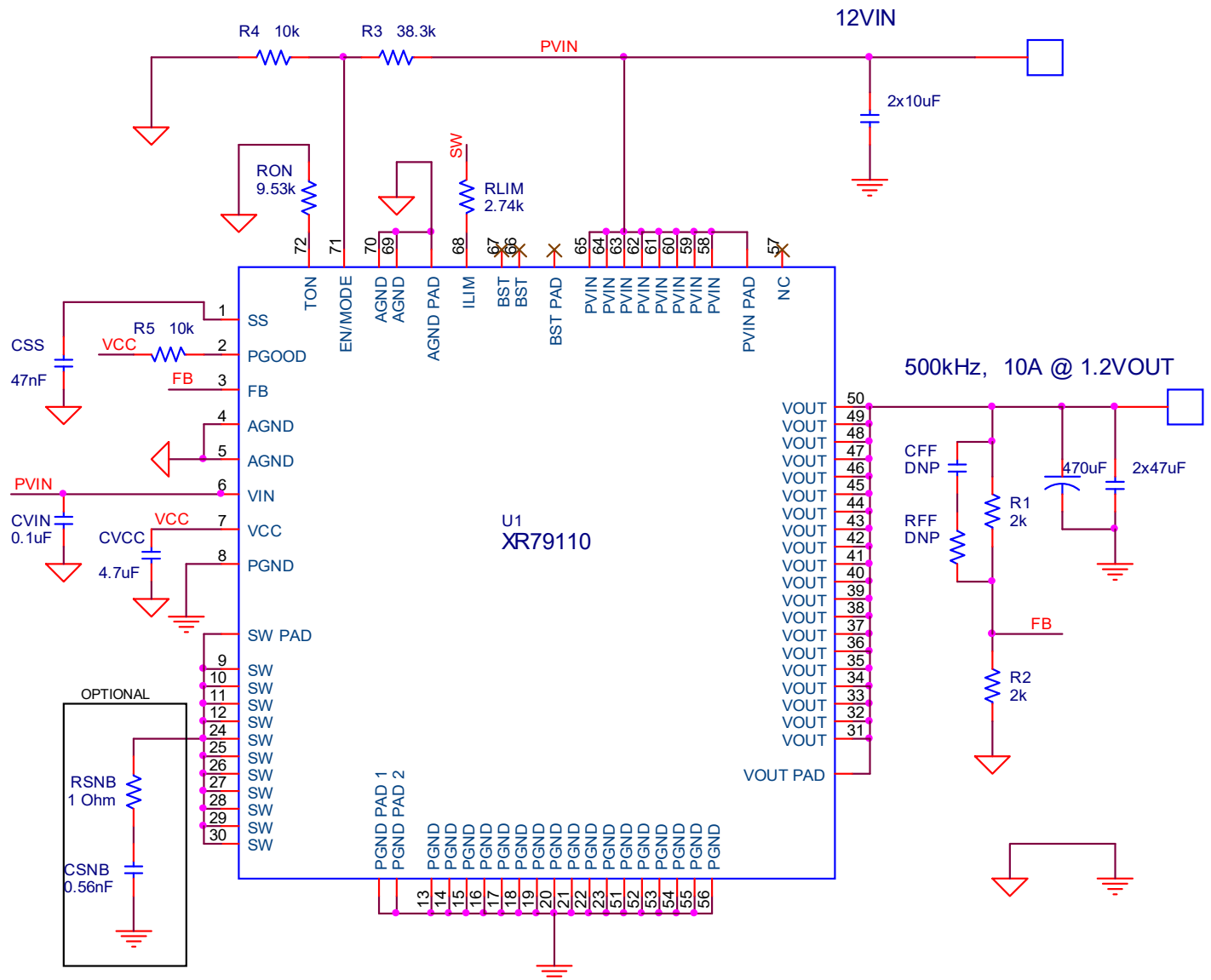
PACKAGE	72L 10x10 SIP−LPCC		
REF.	MIN.	NOM.	MAX.
A	3.90	4.00	4.10
b	0.20	0.25	0.30
L	0.50	0.60	0.70
D	10.00 BSC		
D1	1.94	2.04	2.14
D2	3.45	3.55	3.65
D3	5.26	5.36	5.46
D4	3.38	3.48	3.58
D5	2.735	2.835	2.935
D6	1.28	1.38	1.48
D7	1.975	2.075	2.175
D8	0.45	0.55	0.65
D9	0.45	0.55	0.65
E	10.00 BSC		
E1	6.30	6.40	6.50
E2	1.05	1.15	1.25
E3	6.30	6.40	6.50
E4	0.78	0.88	0.98
E5	2.425	2.525	2.625
E6	1.98	2.08	2.18
E7	1.975	2.075	2.175
E8	1.05	1.15	1.25
E9	1.05	1.15	1.25
e	0.50 BSC		
n	72		
nD	19		
nE	17		

SYMBOL	COMMON DIMENSIONS			NOTE
	MIN.	NOM.	MAX.	
A1	0	0.02	0.05	
A3	0.20 REF.			
TOLERANCES OF FORM AND POSITION				
aaa	0.10			
bbb	0.10			
ccc	0.10			
ddd	0.05			
eee	0.08			

TERMINAL DETAILS
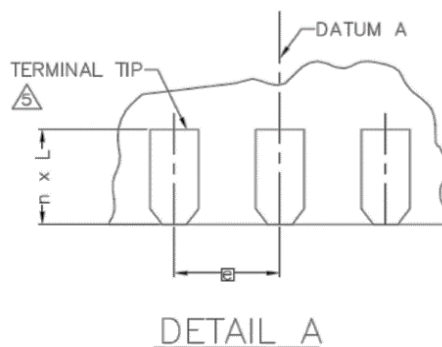
DETAIL A

Drawing No. : POD - 00000099

Revision: B

Pad Edge Details
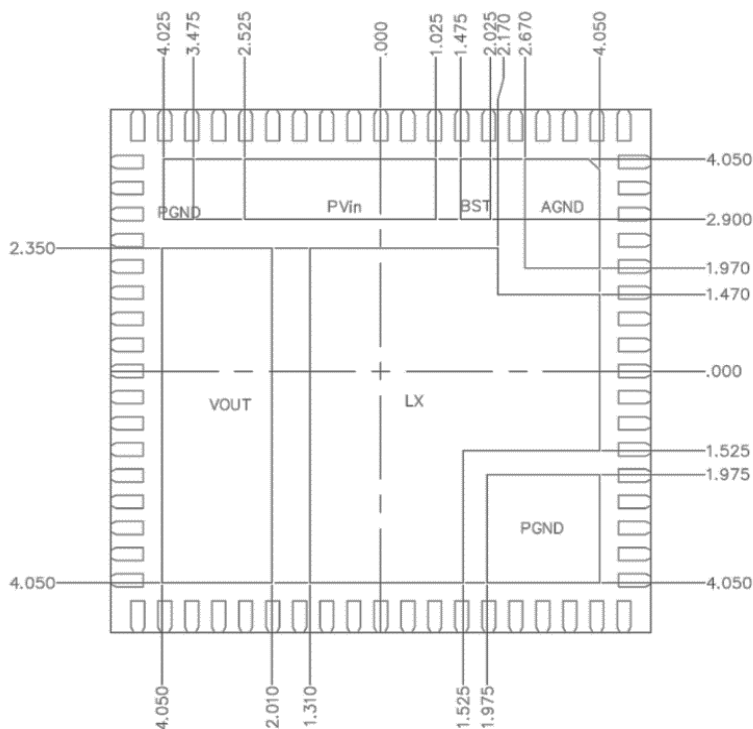
PAD EDGE DETAILS

NOTES:

1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5—1994.

2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.

3. n IS THE TOTAL NUMBER OF TERMINALS.

4. THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JEDEC PUBLICATION 95 SPP—002. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.

5. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP.

6. nD AND nE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

7. DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

8. TOLERANCE FOR EXPOSED DAP EDGE LOCATION DIMENSION IN PAGE 2 IS +/−0.1MM.

9. DRAWING DOES NOT INCLUDE PLASTIC OR METAL PROTRUSION OR CUTTING BURR

Drawing No. : POD - 00000099

Revision: B

Recommended Land Pattern and Stencils Designs
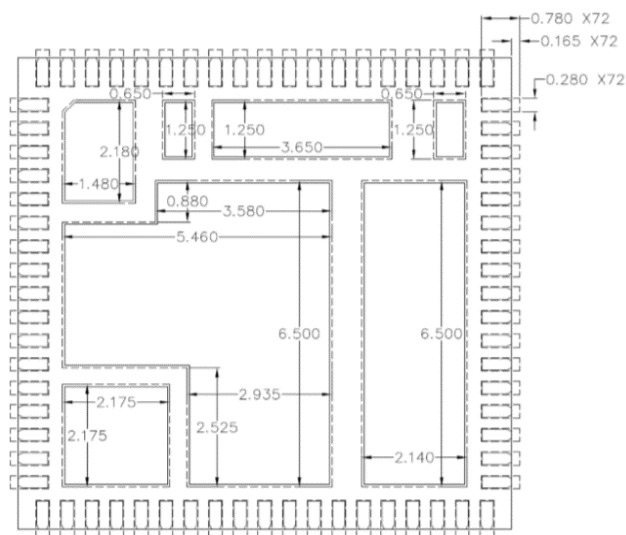
RECOMMENDED LAND PATTERN DESIGN   Note) Dash line refers to land pattern
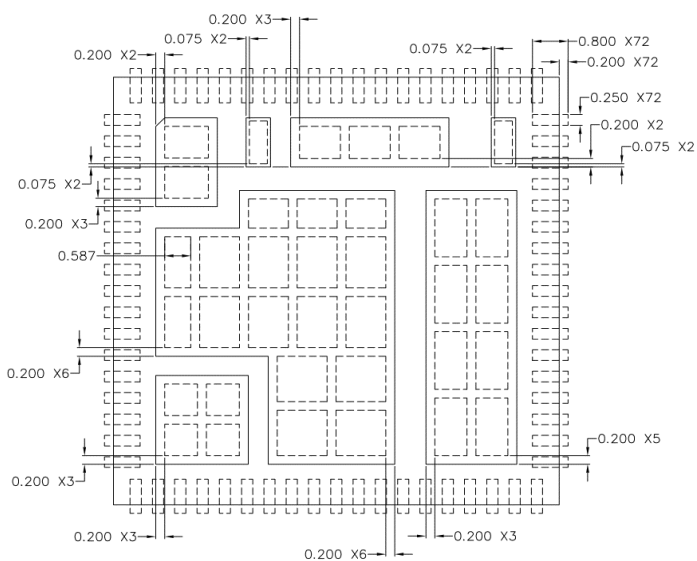
RECOMMENDED STENCIL DESIGN   Note) Dash line refers to solder stencil opening

Drawing No. : POD - 00000099

Revision: B

Ordering Information[1]

Table 1:

Part Number	Operating Temperature Range	Lead-Free	Package	Packaging Method
XR79110EL-F	-40°C ≤ T_J ≤ +125°C	Yes[2]	10x10mm QFN	Tray
XR79110EVB	XR79110 Evaluation Board			

NOTE:

1. Refer to www.exar.com/XR79110 for most up-to-date Ordering Information.

2. Visit www.exar.com for additional information on Environmental Rating

Revision History

Revision	Date	Description
1A	December 2014	ECN 1451-08
1B	January 2015	Corrected schematic on page 1, ECN 1504-05
1C	June 2015	Added CFF/RFF to Application Circuit, updated figure 12, added writeup "maximum allowable ripple at FB pin" and "VOUT versus frequency curves"
2A	January 2016	Changed minimum VIN to 4.5V, Added CDM rating, changed VCC(MIN)=4.3V at VIN=4.5V, added VCC UVLO Hysteresis min=150mV across temperature, changed POD
2B	May 2017	Added more transient information to Note 2 under Absolute Maximum Ratings. Updated package drawing and ordering information format.
2C	January 2018	Updated to MaxLinear logo. Updated format and Ordering Information. Added $5V_{OUT}$ to Figures 21 and 22. Clarified operating temperature range in Ordering Information. Changed switching frequency upper limit to 800kHz.

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